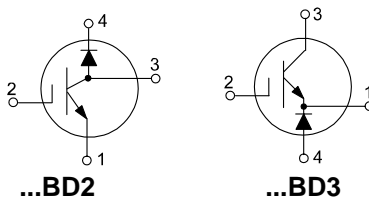


# HiPerFAST™ IGBT with HiPerFRED

## IXGN 50N60BD2 IXGN 50N60BD3

Buck & boost configurations

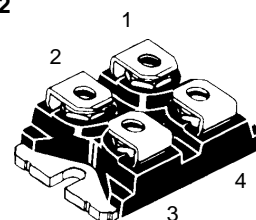


$$\begin{aligned} V_{CES} &= 600 \text{ V} \\ I_{C25} &= 75 \text{ A} \\ V_{CE(sat)} &= 2.5 \text{ V} \\ t_{fi} &= 150 \text{ ns} \end{aligned}$$

|       | Symbol              | Test Conditions  | Maximum Ratings                   |                  |
|-------|---------------------|--|-----------------------------------|------------------|
| IGBT  | $V_{CES}$           | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$  | 600                               | V                |
|       | $V_{CGR}$           | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GE} = 1 \text{ M}\Omega$   | 600                               | V                |
|       | $V_{GES}$           | Continuous   | $\pm 20$                          | V                |
|       | $V_{GEM}$           | Transient  | $\pm 30$                          | V                |
|       | $I_{C25}$           | $T_C = 25^\circ\text{C}$   | 75                                | A                |
|       | $I_{C90}$           | $T_C = 90^\circ\text{C}$   | 50                                | A                |
|       | $I_{CM}$            | $T_C = 25^\circ\text{C}$ , 1 ms  | 200                               | A                |
|       | <b>SSOA (RBSOA)</b> | $V_{GE} = 15 \text{ V}$ , $T_{VJ} = 125^\circ\text{C}$ , $R_G = 10 \Omega$<br>Clamped inductive load, $L = 30 \mu\text{H}$ | $I_{CM} = 100$<br>@ $0.8 V_{CES}$ | A                |
| Diode | $P_C$               | $T_C = 25^\circ\text{C}$   | 250                               | W                |
|       | $V_{RRM}$           |  | 600                               | V                |
|       | $I_{FAVM}$          | $T_C = 70^\circ\text{C}$ ; rectangular, $d = 50\%$   | 60                                | A                |
|       | $I_{FRM}$           | $t_p < 10 \text{ ms}$ ; pulse width limited by $T_J$   | 600                               | A                |
|       | $P_D$               | $T_C = 25^\circ\text{C}$   | 150                               | W                |
| Case  | $T_J$               |  | -40 ... +150                      | $^\circ\text{C}$ |
|       | $T_{JM}$            |  | 150                               | $^\circ\text{C}$ |
|       | $T_{stg}$           |  | -40 ... +150                      | $^\circ\text{C}$ |
|       | $M_d$               | Mounting torque  | 1.5/13                            | Nm/lb.in.        |
|       |                     | Terminal connection torque (M4)  | 1.5/13                            | Nm/lb.in.        |
|       | <b>Weight</b>       |  | 30                                | g                |
|       |                     | Maximum lead temperature for soldering<br>1.6 mm (0.062 in.) from case for 10 s  | 300                               | $^\circ\text{C}$ |

SOT-227B, miniBLOC

E 153432



IXGN50N60BD2

1 = Emitter; 2 = Gate  
3 = Collector; 4 = Diode cathode

IXGN50N60BD3

1 = Emitter/Diode Cathode; 2 = Gate  
3 = Collector; 4 = Diode anode

### Features

- International standard package miniBLOC
- Aluminium nitride isolation
  - high power dissipation
- Isolation voltage 3000 V~
- Very high current, fast switching IGBT & FRED diode
- MOS Gate turn-on
  - drive simplicity
- Low collector-to-case capacitance
- Low package inductance ( $< 10 \text{ nH}$ )
  - easy to drive and to protect
- Molding epoxies meet UL 94 V-0 flammability classification

### Applications

- AC motor speed control
- DC servo and robot drives
- DC choppers
- Buck converters

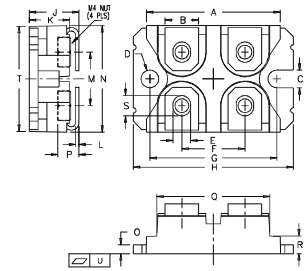
### Advantages

- Easy to mount with 2 screws
- Space savings
- High power density

| Symbol        | Test Conditions  | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |  |
|---------------|--|---|------|--|
|               |  | min.  | typ. | max.   |
| $BV_{CES}$    | $I_C = 250 \mu\text{A}$ , $V_{GE} = 0 \text{ V}$       | 600   |      | V  |
| $V_{GE(th)}$  | $I_C = 250 \mu\text{A}$ , $V_{CE} = V_{GE}$            | 2.5   |      | 5 V  |
| $I_{CES}$     | $V_{CE} = 0.8 \cdot V_{CES}$<br>$V_{GE} = 0 \text{ V}$ |   |      | $T_J = 25^\circ\text{C}$<br>200 $\mu\text{A}$<br>$T_J = 125^\circ\text{C}$<br>1 mA |
| $I_{GES}$     | $V_{CE} = 0 \text{ V}$ , $V_{GE} = \pm 20 \text{ V}$   |   |      | $\pm 100 \text{ nA}$   |
| $V_{CE(sat)}$ | $I_C = I_{C90}$ , $V_{GE} = 15 \text{ V}$              |   |      | 2.5 V  |

| Symbol       | Test Conditions  | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |          |
|--------------|--|---|------|----------|
|              |  | min.  | typ. | max.     |
| $g_{fs}$     | $I_C = I_{C90}, V_{CE} = 10\text{ V}$ ,<br>Pulse test, $t \leq 300\text{ }\mu\text{s}$ , duty cycle $\leq 2\%$   | 35  | 50   | S        |
| $C_{ies}$    | $V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$ , $f = 1\text{ MHz}$  |   | 4100 | pF       |
| $C_{oes}$    |  |   | 290  | pF       |
| $C_{res}$    |  |   | 50   | pF       |
| $Q_g$        | $I_C = I_{C90}, V_{GE} = 15\text{ V}$ , $V_{CE} = 0.5 V_{CES}$   |   | 110  | nC       |
| $Q_{ge}$     |  |   | 30   | nC       |
| $Q_{gc}$     |  |   | 35   | nC       |
| $t_{d(on)}$  | <b>Inductive load, <math>T_J = 25^\circ\text{C}</math></b><br>$I_C = I_{C90}, V_{GE} = 15\text{ V}$ , $L = 100\text{ }\mu\text{H}$ ,<br>$V_{CE} = 0.8 V_{CES}$ , $R_G = R_{off} = 2.7\text{ }\Omega$<br>Remarks: Switching times may increase<br>for $V_{CE}(\text{Clamp}) > 0.8 \cdot V_{CES}$ , higher $T_J$ or<br>increased $R_G$ |   | 50   | ns       |
| $t_{ri}$     |  |   | 50   | ns       |
| $t_{d(off)}$ |  |   | 110  | 250 ns   |
| $t_{fi}$     |  |   | 150  | 220 ns   |
| $E_{off}$    |  |   | 3.0  | 4.0 mJ   |
| $t_{d(on)}$  |  |   | 50   | ns       |
| $t_{ri}$     | <b>Inductive load, <math>T_J = 125^\circ\text{C}</math></b><br>$I_C = I_{C90}, V_{GE} = 15\text{ V}$ , $L = 100\text{ }\mu\text{H}$<br>$V_{CE} = 0.8 V_{CES}$ , $R_G = R_{off} = 2.7\text{ }\Omega$<br>Remarks: Switching times may increase<br>for $V_{CE}(\text{Clamp}) > 0.8 \cdot V_{CES}$ , higher $T_J$ or<br>increased $R_G$  |   | 60   | ns       |
| $E_{on}$     |  |   | 3.0  | mJ       |
| $t_{d(off)}$ |  |   | 200  | ns       |
| $t_{fi}$     |  |   | 250  | ns       |
| $E_{off}$    |  |   | 4.2  | mJ       |
| $R_{thJC}$   |  |   |      | 0.50 K/W |
| $R_{thCK}$   |  | 0.05  |      | K/W      |

### miniBLOC, SOT-227 B



M4 screws (4x) supplied

| Dim. | Millimeter |       | Inches |       |
|------|------------|-------|--------|-------|
|      | Min.       | Max.  | Min.   | Max.  |
| A    | 31.50      | 31.88 | 1.240  | 1.255 |
| B    | 7.80       | 8.20  | 0.307  | 0.323 |
| C    | 4.09       | 4.29  | 0.161  | 0.169 |
| D    | 4.09       | 4.29  | 0.161  | 0.169 |
| E    | 4.09       | 4.29  | 0.161  | 0.169 |
| F    | 14.91      | 15.11 | 0.587  | 0.595 |
| G    | 30.12      | 30.30 | 1.186  | 1.193 |
| H    | 38.00      | 38.23 | 1.496  | 1.505 |
| J    | 11.68      | 12.22 | 0.460  | 0.481 |
| K    | 8.92       | 9.60  | 0.351  | 0.378 |
| L    | 0.76       | 0.84  | 0.030  | 0.033 |
| M    | 12.60      | 12.85 | 0.496  | 0.506 |
| N    | 25.15      | 25.42 | 0.990  | 1.001 |
| O    | 1.98       | 2.13  | 0.078  | 0.084 |
| P    | 4.95       | 5.97  | 0.195  | 0.235 |
| Q    | 26.54      | 26.90 | 1.045  | 1.059 |
| R    | 3.94       | 4.42  | 0.155  | 0.174 |
| S    | 4.72       | 4.85  | 0.186  | 0.191 |
| T    | 24.59      | 25.07 | 0.968  | 0.987 |
| U    | -0.05      | 0.1   | -0.002 | 0.004 |

### Reverse Diode (FRED) Characteristic Values

( $T_J = 25^\circ\text{C}$ , unless otherwise specified)

| Symbol     | Test Conditions  | typ. | max.              |
|------------|--|------|-------------------|
| $I_R$      | $T_{VJ} = 25^\circ\text{C}$ $V_R = V_{RRM}$  |      | 650 $\mu\text{A}$ |
|            | $T_{VJ} = 150^\circ\text{C}$   |      | 2.5 mA            |
| $V_F$      | $I_F = 60\text{ A}$ , $T_{VJ} = 150^\circ\text{C}$   |      | 1.75 V            |
|            | Pulse test, $t \leq 300\text{ }\mu\text{s}$ , duty cycle $d \leq 2\%$ $T_{VJ} = 25^\circ\text{C}$        |      | 2.40 V            |
| $I_{RM}$   | $I_F = I_{C90}, V_{GE} = 0\text{ V}$ , $-di_F/dt = 100\text{ A}/\mu\text{s}$<br>$V_R = 540\text{ V}$     |      | 8.0 A             |
| $t_{rr}$   | $I_F = 1\text{ A}$ , $-di_F/dt = 50\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$ $T_J = 25^\circ\text{C}$ | 35   | ns                |
| $R_{thJC}$ |  |      | 0.85 K/W          |

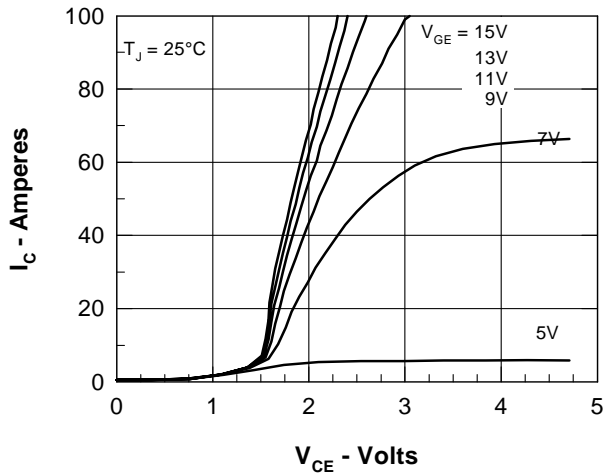


Fig. 1. Saturation Voltage Characteristics

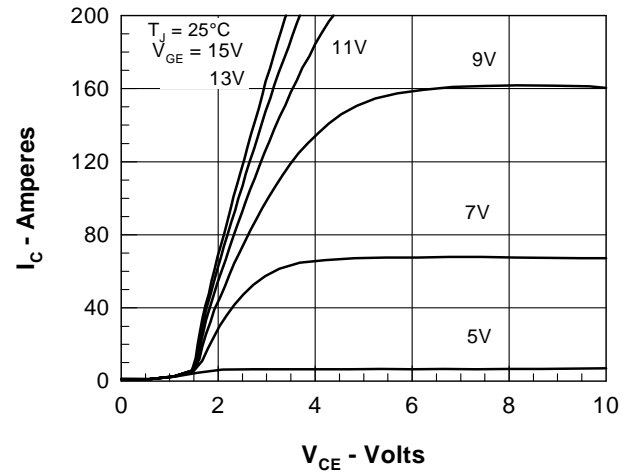


Fig. 2. Extended Output Characteristics

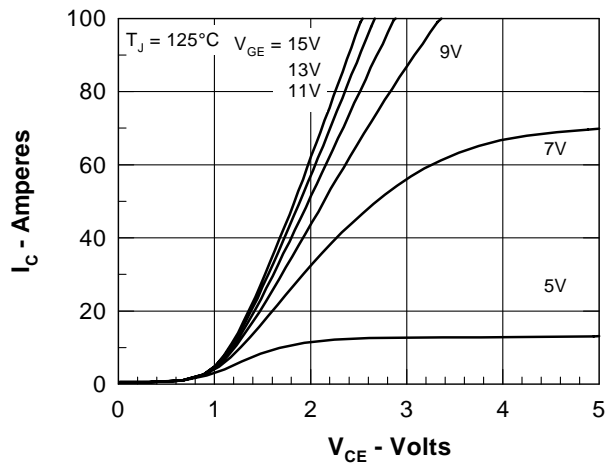


Fig. 3. Saturation Voltage Characteristics

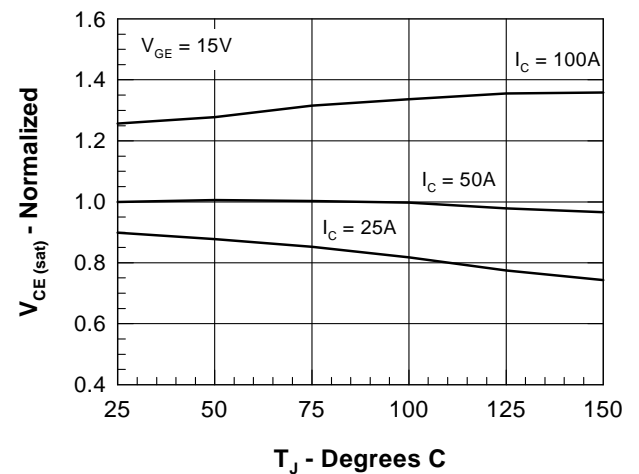


Fig. 4. Temperature Dependence of  $V_{CE(sat)}$

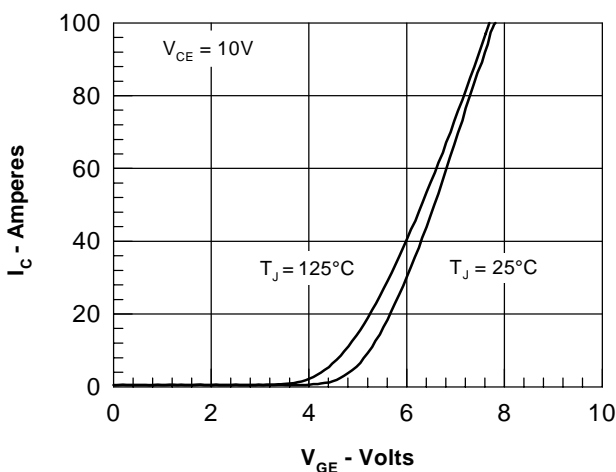


Fig. 5. Saturation Voltage Characteristics

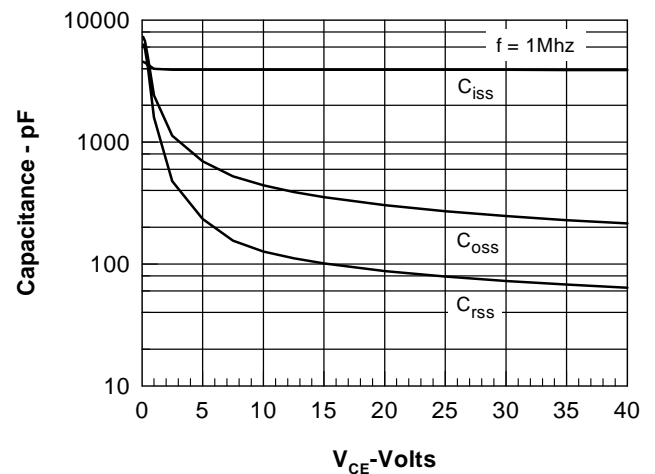


Fig. 6. Junction Capacitance Curves

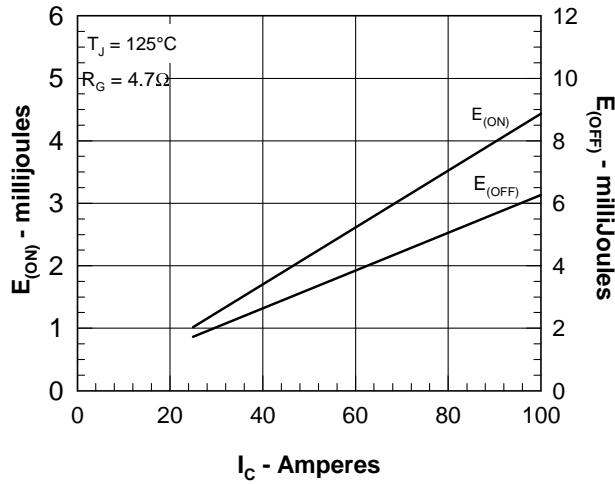


Fig. 7. Dependence of  $E_{ON}$  and  $E_{OFF}$  on  $I_C$ .

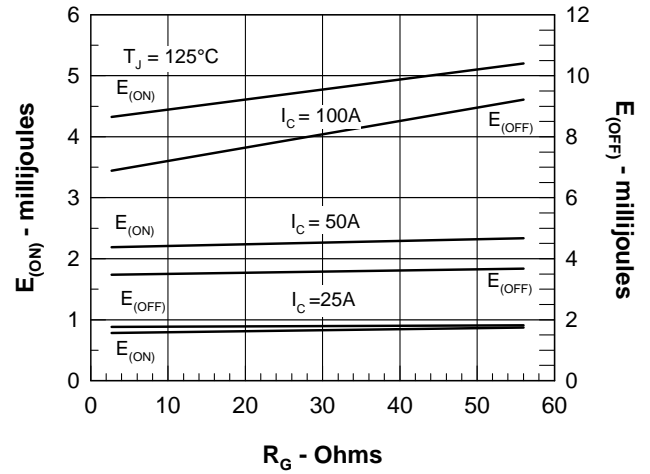


Fig. 8. Dependence of  $t_{fi}$  and  $E_{OFF}$  on  $R_G$ .

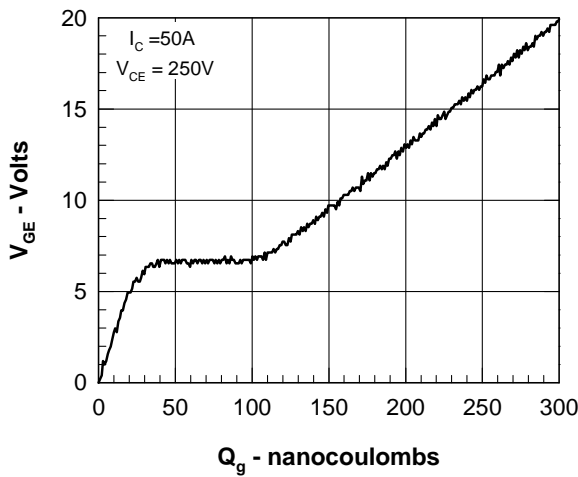


Fig. 9. Gate Charge

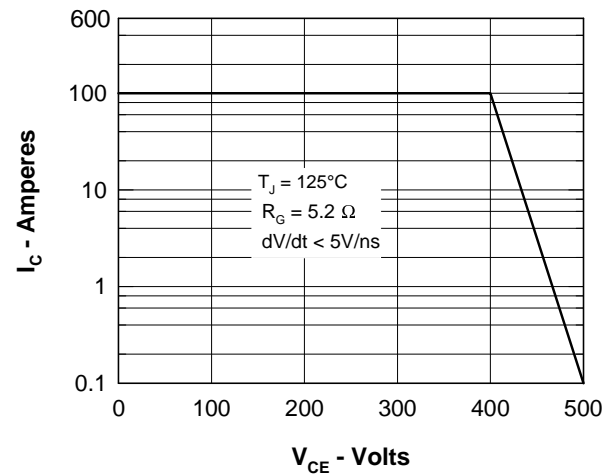


Fig. 10. Turn-off Safe Operating Area

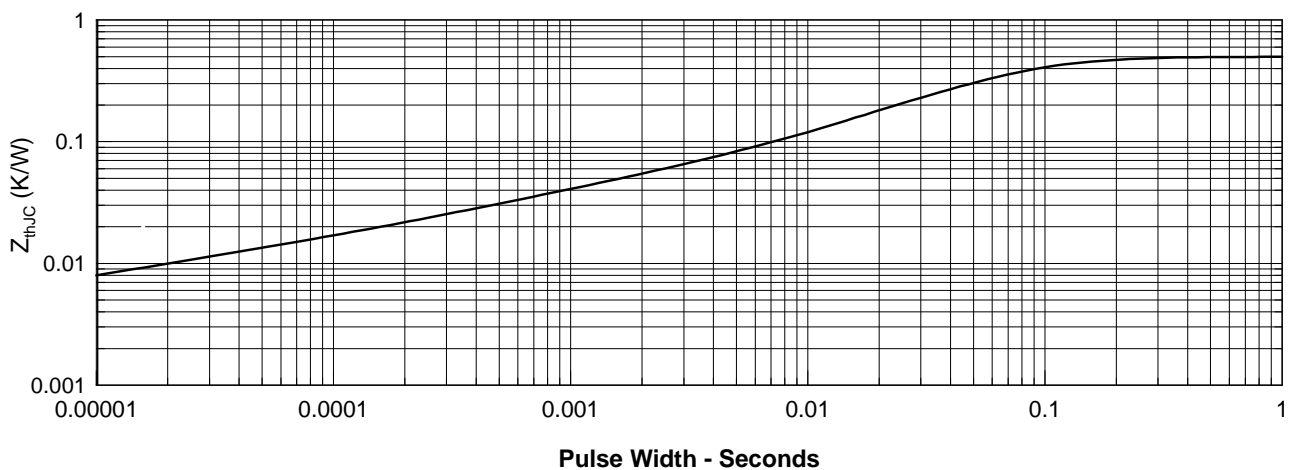


Fig. 11. Transient Thermal Resistance

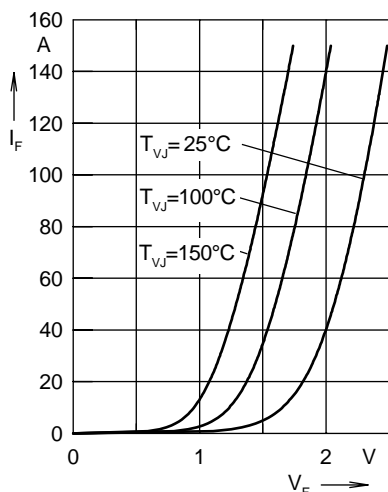


Fig. 12 Forward current  $I_F$  versus  $V_F$

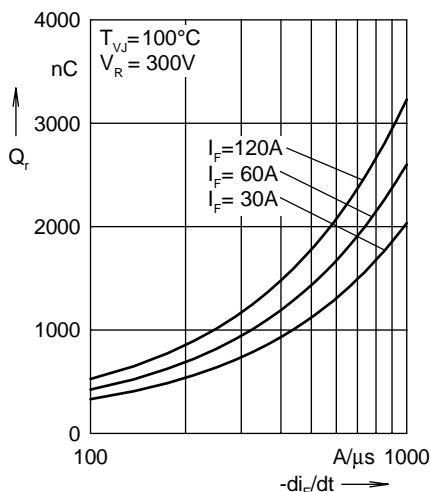


Fig. 13 Reverse recovery charge  $Q_r$  versus  $-di_F/dt$

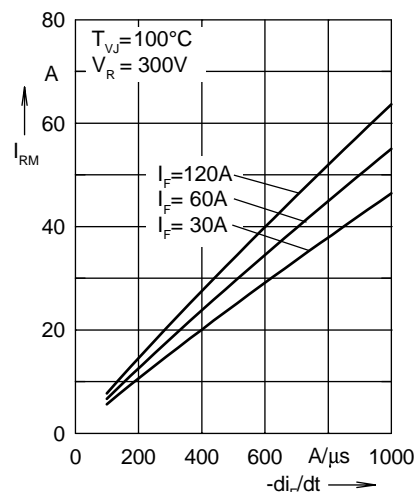


Fig. 14 Peak reverse current  $I_{RM}$  versus  $-di_F/dt$

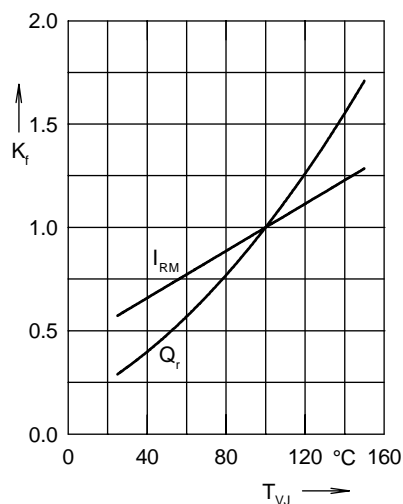


Fig. 15 Dynamic parameters  $Q_r$ ,  $I_{RM}$  versus  $T_{VJ}$

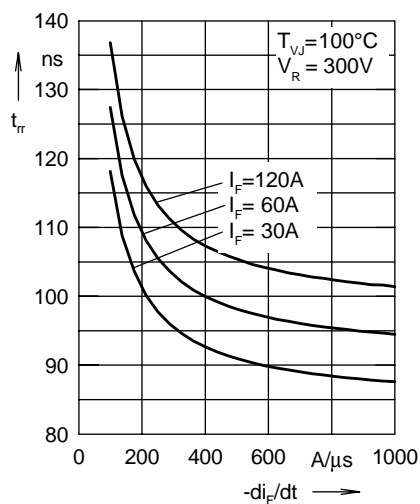


Fig. 16 Recovery time  $t_{rr}$  versus  $-di_F/dt$

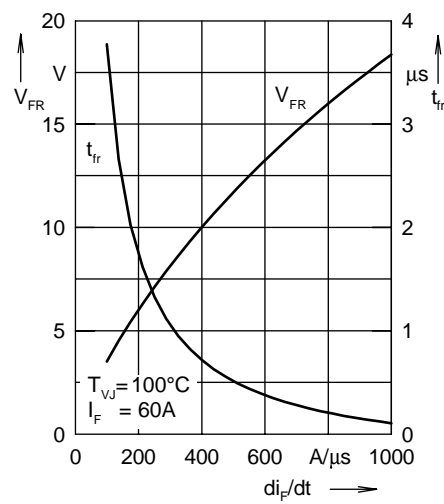


Fig. 17 Peak forward voltage  $V_{FR}$  and  $t_{fr}$  versus  $di_F/dt$

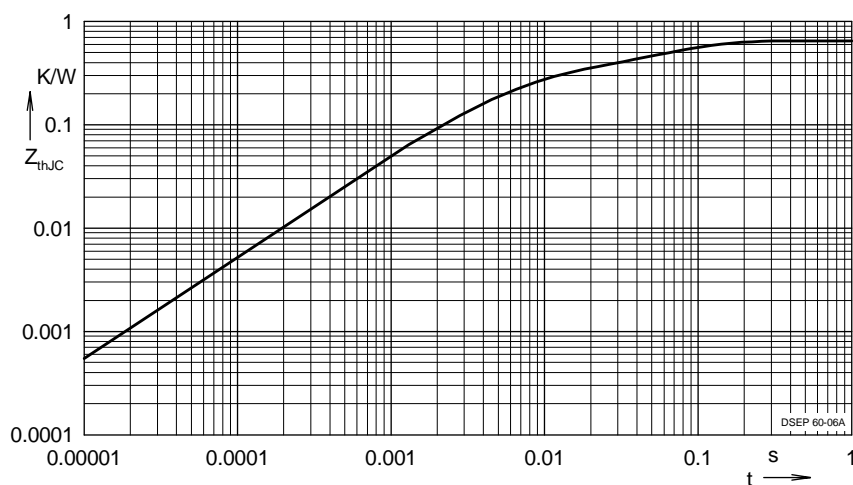


Fig. 18 Transient thermal resistance junction to case

Constants for  $Z_{thJC}$  calculation:

| i | $R_{thi}$ (K/W) | $t_i$ (s) |
|---|-----------------|-----------|
| 1 | 0.324           | 0.0052    |
| 2 | 0.125           | 0.0003    |
| 3 | 0.201           | 0.0385    |